



In Re Application of:

Kong Weng Lee

Serial No.: 10/608,605

Filed: 6/27/2003

Confirmation No.: 2253

Group Art Unit: 2811

Examiner: Owens, Douglas W

Docket No. 70030259-1

For: Packaging Device for Semiconductor Die, Semiconductor Device Incorporating Same and Method of Making Same

AMENDMENT AND RESPONSE TO ADVISORY ACTION

Mail Stop – RCE
Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir:

Applicants respectfully request entry of the following amendments and remarks contained herein in response to the outstanding Advisory Action mailed June 23, 2006. Applicants respectfully submit that the amendment and remarks contained herein place the instant application in condition for allowance. A Request for Continued Examination under 37 U.S.C. §1.114, together with a one-month extension of time, is being filed concurrently with this response to the Advisory Action. Consequently, Applicants respectfully submit that the final Office Action mailed April 6, 2006 is effectively made non-final.

AUTHORIZATION TO DEBIT ACCOUNT

It is not believed that extensions of time or fees for net addition of claims are required, beyond those that may otherwise be provided for in documents accompanying this paper. However, in the event that additional extensions of time are necessary to allow consideration of this paper, such extensions are hereby petitioned under 37 C.F.R. § 1.136(a), and any fees required therefor (including fees for net addition of claims) are hereby authorized to be charged to Avago deposit account no. 50-3718.